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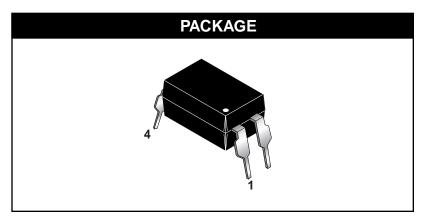
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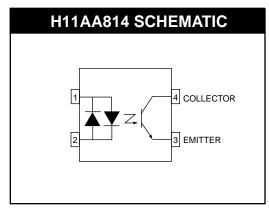


H11AA814 SERIES

**H11A617 SERIES** 

H11A817 SERIES





#### DESCRIPTION

The H11AA814 Series consists of two gallium arsenide infrared emitting diodes, connected in inverse parallel, driving a single silicon phototransistor in a 4-pin dual in-line package.

The H11A617 and H11A817 Series consists of a gallium arsenide infrared emitting diode driving a silicon phototransistor in a 4-pin dual in-line package.

#### **FEATURES**

- · Compact 4-pin package
- Current transfer ratio in selected groups:

 H11AA814:
 20-300%
 H11A817:
 50-600%

 H11AA814A:
 50-150%
 H11A817A:
 80-160%

 H11A617A:
 40%-80%
 H11A817B:
 130-260%

 H11A617C:
 100%-200%
 H11A817C:
 200-400%

 H11A817D:
 300-600%

H11A617D: 160%-320%

Minimum BV<sub>CFO</sub> of 70V guaranteed

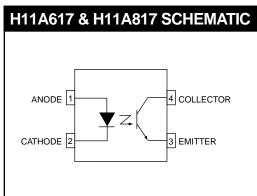
#### **APPLICATIONS**

H11AA814 Series

- AC line monitor
- Unknown polarity DC sensor
- Telephone line interface

#### H11A617 and H11A817 Series

- Power supply regulators
- Digital logic inputs
- Microprocessor inputs





#### H11AA814 SERIES

#### **H11A617 SERIES**

**H11A817 SERIES** 

Parameter	Symbol	Device	Value	Units
TOTAL DEVICE				
Storage Temperature	T <sub>STG</sub>	All	-55 to +150	°C
Operating Temperature	T <sub>OPR</sub>	All	-55 to +100	°C
Lead Solder Temperature	T <sub>SOL</sub>	All	260 for 10 sec	°C
Total Device Power Dissipation (-55°C to 50 °C)	P <sub>D</sub>	All	200	mW
EMITTER				
Continuous Forward Current	I <sub>F</sub>	All	50	mA
Reverse Voltage	V <sub>R</sub>	H11A617A/B/C/D H11A817/A/B/C/D	6 5	V
Forward Current - Peak (1 µs pulse, 300 pps)	I <sub>F</sub> (pk)	All	1.0	А
LED Power Dissipation (25°C ambient) Derate above 25°C	P <sub>D</sub>	All	100 1.33	mW mW/°C
DETECTOR				
Collector-Emitter Voltage	V <sub>CEO</sub>	All	70	V
Emitter-Collector Voltage	V <sub>ECO</sub>	H11AA814/A H11A617A/B/C/D H11A817/A/B/C/D	6 7 6	V
Continuous Collector Current	I <sub>C</sub>	All	50	mA
Detector Power Dissipation (25°C ambient)	P <sub>D</sub> All		150	mW
Derate above 25°C	' D	All	2.0	mW/°C

#### **ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = 25°C Unless otherwise specified.) INDIVIDUAL COMPONENT CHARACTERISTICS **Parameter Test Conditions Symbol Device** Min Typ\* Max Unit **EMITTER** $(I_F = 60 \text{ mA})$ 1.35 H11A617A/B/C/D 1.65 $(I_F = 20 \text{ mA})$ $V_{\mathsf{F}}$ H11A817/A/B/C/D 1.2 1.5 V Input Forward Voltage $(I_F = \pm 20 \text{ mA})$ H11AA814/A 1.2 1.5 $(V_R = 6.0 V)$ H11A617A/B/C/D Reverse Leakage Current $I_R$ .001 10 μΑ $(V_R = 5.0 V)$ H11A817/A/B/C/D DETECTOR Collector-Emitter Breakdown $(I_C = 1.0 \text{ mA}, I_F = 0)$ $BV_{CEO}$ 70 100 V ALL Voltage H11AA814/A 6 Emitter-Collector Breakdown $(I_F = 100 \mu A, I_F = 0)$ $BV_{FCO}$ H11A617A/B/C/D 7 10 V Voltage H11A817/A/B/C/D H11AA814/A, H11A817/A/B/C/D, 100 $(V_{CE} = 10V, I_F = 0)$ Collector-Emitter Dark Current H11A617C/D 1 nΑ ICEO H11A617A/B 50 Collector-Emitter Capacitance $(V_{CE} = 0 V, f = 1 MHz)$ $C_{CE}$ ALL 8 рF

<sup>\*</sup>Typical values at  $T_A = 25$ °C.



H11AA814 SERIES

H11A617 SERIES

**H11A817 SERIES** 

DC Characteristic	Test Conditions	Symbol	Device	Min	Тур*	Max	Unit
	$(I_F = \pm 1 \text{ mA}, V_{CE} = 5 \text{ V}) \text{ (note 1)}$		H11AA814	20		300	%
	$(I_F = \pm 1 \text{ mA}, V_{CE} = 5 \text{ V}) \text{ (note 1)}$		H11AA814A	50		150	%
	(I <sub>F</sub> = 10 mA, V <sub>CE</sub> = 5 V) (note 1)	CTR	H11A617A	40		80	%
			H11A617B	63		125	%
			H11A617C	100		200	%
			H11A617D	160		320	%
Current Transfer Ratio	(I <sub>F</sub> = 5 mA, V <sub>CE</sub> = 5 V) (note 1)		H11A817	50		600	%
			H11A817A	80		160	%
			H11A817B	130		260	%
			H11A817C	200		400	%
			H11A817D	300		600	%
	(I <sub>F</sub> = 1 mA, V <sub>CE</sub> = 5 V) (note 1)		H11A617A	13			%
			H11A617B	22			%
			H11A617C	34			%
			H11A617D	56			%
0 11 . 5	$(I_C = 1 \text{ mA}, I_F = \pm 20 \text{ mA})$		H11AA814/A			0.2	
Collector-Emitter Saturation Voltage	$(I_C = 2.5 \text{ mA}, I_F = 10 \text{ mA})$	V <sub>CE (SAT)</sub>	H11A617A/B/C/D			0.4	V
	$(I_C = 1 \text{ mA}, I_F = 20 \text{ mA})$		H11A817/A/B/C/D			0.2	ĺ
AC Characteristic							
Rise Time	$(I_C = 2 \text{ mA}, V_{CE} = 2 \text{ V}, R_L = 100\Omega) \text{ (note 2)}$	t <sub>r</sub>	ALL		2.4	18	μs
Fall Time	$(I_C = 2 \text{ mA}, V_{CE} = 2 \text{ V}, R_L = 100\Omega) \text{ (note 2)}$	t <sub>f</sub>	ALL		2.4	18	μs

ISOLATION CHARACTERISTICS						
Characteristic	Test Conditions	Symbol	Min	Тур*	Max	Units
Input-Output Isolation Voltage (note 3)	f = 60Hz, t = 1 min	V <sub>ISO</sub>	5300			Vac(rms)
Isolation Resistance	(V <sub>I-O</sub> = 500 VDC)	R <sub>ISO</sub>	10 <sup>11</sup>			Ω
Isolation Capacitance	$(V_{I-O} = 0, f = 1 \text{ MHz})$	C <sub>ISO</sub>		0.5		pf

<sup>\*</sup>Typical values at  $T_A = 25$ °C.

#### **NOTES**

- 1. Current Transfer Ratio (CTR) =  $I_C/I_F \times 100\%$ .
- 2. For test circuit setup and waveforms, refer to Figure 8.
- 3. For this test, Pins 1 and 2 are common, and Pins 3 and 4 are common.



#### H11AA814 SERIES

### H11A617 SERIES

### H11A817 SERIES

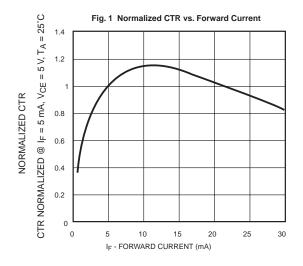


Fig. 3 Collector-Emitter Saturation Voltage vs. Ambient Temperature

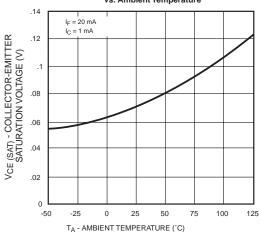
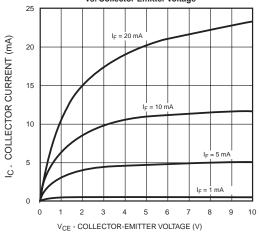


Fig. 5 Collector Current vs. Collector-Emitter Voltage



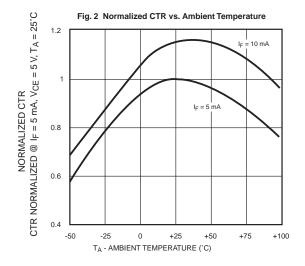
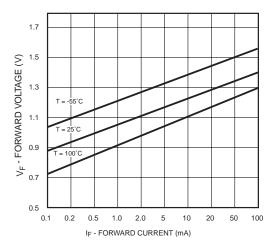


Fig. 4 Forward Voltage vs. Forward Current

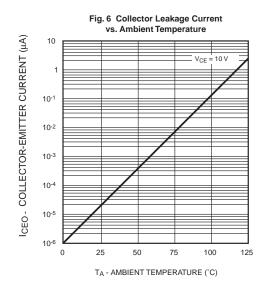




H11AA814 SERIES

**H11A617 SERIES** 

**H11A817 SERIES** 



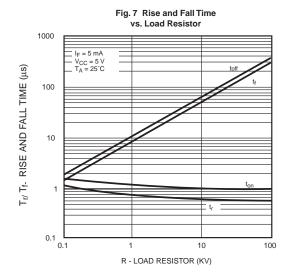
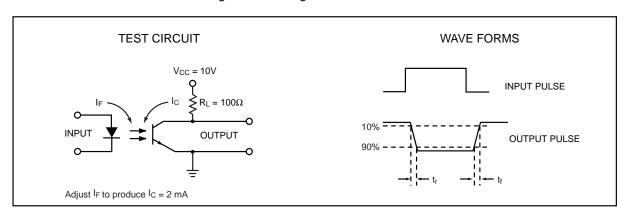
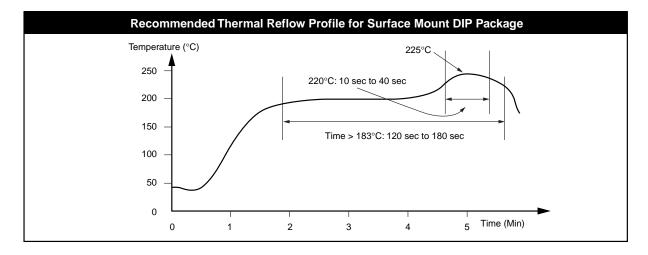


Figure 8. Switching Time Test Circuit and Waveforms



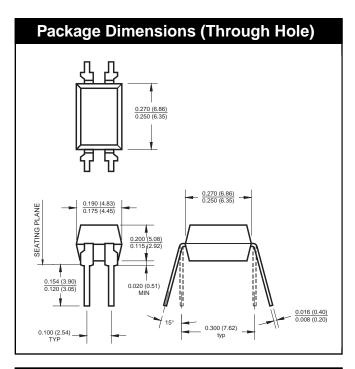


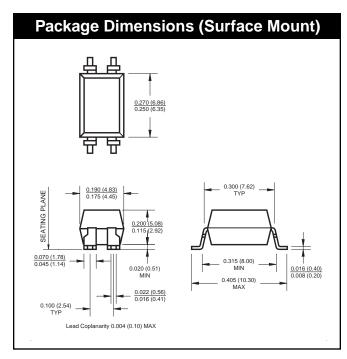


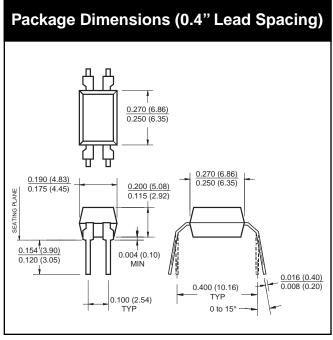
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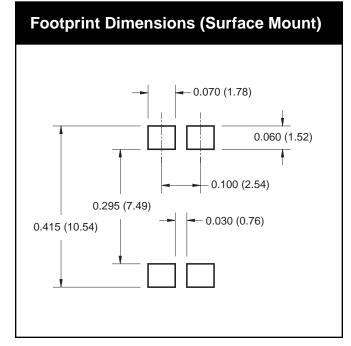
**H11A617 SERIES** 

**H11A817 SERIES** 









### **NOTE**All dimensions are in inches (millimeters)



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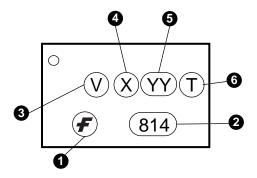
H11A617 SERIES

**H11A817 SERIES** 

#### ORDERING INFORMATION

Option	Order Entry Identifier	Description	
S	.S	Surface Mount Lead Bend	
SD	.SD	Surface Mount; Tape and reel	
W	.W	0.4" Lead Spacing	
300	.300	VDE 0884	
300W	.300W	VDE 0884, 0.4" Lead Spacing	
3S	.3S	VDE 0884, Surface Mount	
3SD	.3SD	VDE 0884, Surface Mount, Tape & Reel	

#### **MARKING INFORMATION**



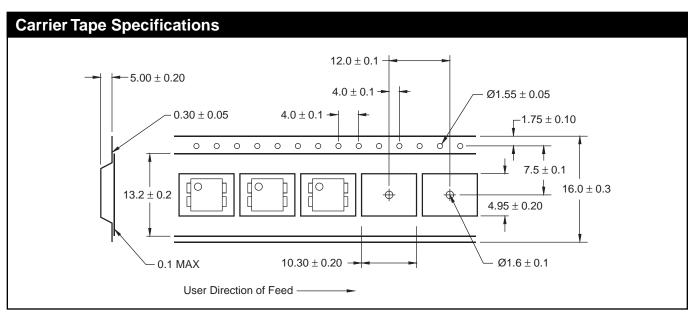
Definitions			
1	Fairchild logo		
2	Device number		
3	VDE mark (Note: Only appears on parts ordered with VDE option – See order entry table)		
4	One digit year code		
5	Two digit work week ranging from '01' to '53'		
6	Assembly package code		



H11AA814 SERIES

**H11A617 SERIES** 

**H11A817 SERIES** 



**NOTE**All dimensions are in millimeters



H11AA814 SERIES

H11A617 SERIES

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